

# PS7141E-2A, PS7141EL-2A

8-PIN DIP, 400 V BREAK DOWN VOLTAGE  
NORMALLY OPEN TYPE  
2-ch Optical Coupled MOS FET

—NEPOC Series—

## DESCRIPTION

The PS7141E-2A and PS7141EL-2A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7141EL-2A has a surface mount type lead.

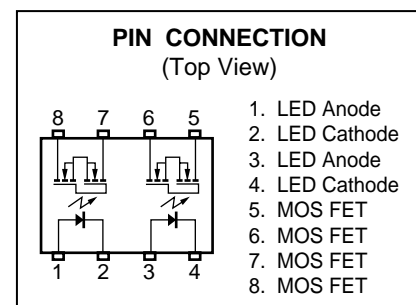
## FEATURES

- 2 channel type (1 a + 1 a output)
- Low LED operating current ( $I_f = 5 \text{ mA}$ )
- Designed for AC/DC switching line changer
- Small package (8-pin DIP)
- Low offset voltage
- Ordering number of taping product: PS7141EL-2A-E3, E4
- Pb-Free product
- Safety standards
  - UL approved: File No. E72422
  - BSI awaiting approval

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## APPLICATIONS

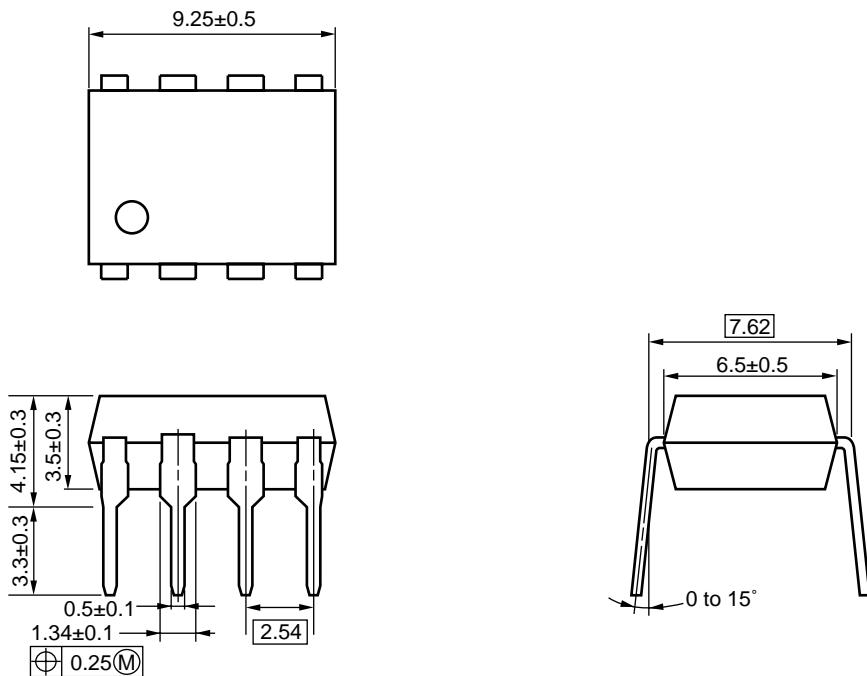
- Exchange equipment
- Measurement equipment
- FA/OA equipment



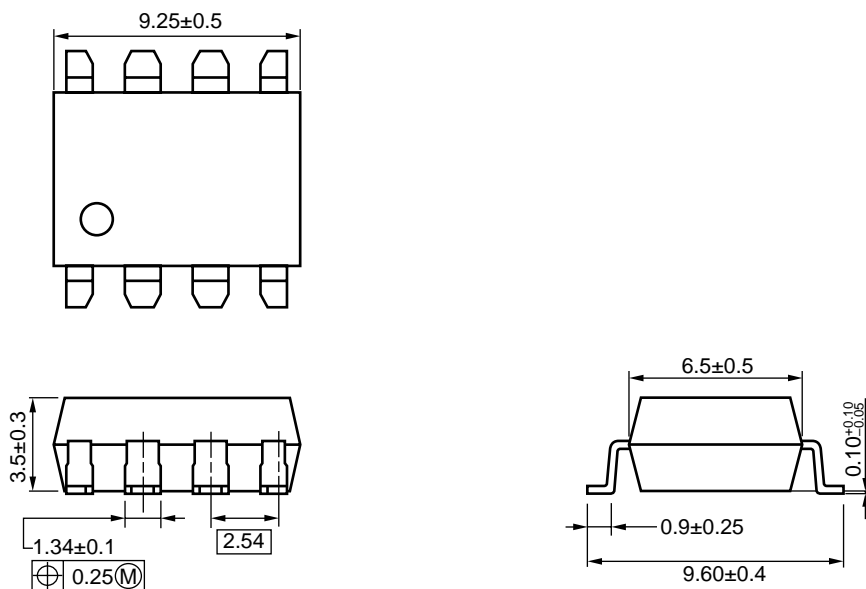
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**PACKAGE DIMENSIONS (in millimeters)**

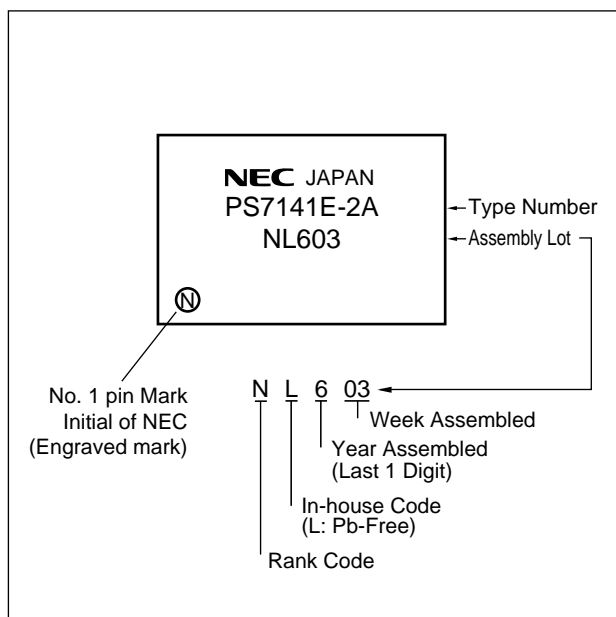
**PS7141E-2A**



**PS7141EL-2A**



**MARKING EXAMPLE**



**<R> ORDERING INFORMATION**

| Part Number    | Order Number     | Solder Plating Specification | Packing Style                | Safety Standard Approval | Application Part Number*1 |
|----------------|------------------|------------------------------|------------------------------|--------------------------|---------------------------|
| PS7141E-2A     | PS7141E-2A-A     | Pb-Free                      | Magazine case 50 pcs         | Standard products        | PS7141E-2A                |
| PS7141EL-2A    | PS7141EL-2A-A    |                              |                              | (UL approved)            |                           |
| PS7141EL-2A-E3 | PS7141EL-2A-E3-A |                              | Embossed Tape 1 000 pcs/reel | BSI awaiting approval    |                           |
| PS7141EL-2A-E4 | PS7141EL-2A-E4-A |                              |                              |                          |                           |

\*1 For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)**

| Parameter                       |  | Symbol           | Ratings     | Unit    |
|---------------------------------|--|------------------|-------------|---------|
| Diode                           | Forward Current (DC)                                   | I <sub>F</sub>   | 50          | mA/ch   |
|                                 | Reverse Voltage  | V <sub>R</sub>   | 5.0         | V       |
|                                 | Power Dissipation                                      | P <sub>D</sub>   | 50          | mW/ch   |
|                                 | Peak Forward Current <sup>*1</sup>                     | I <sub>FP</sub>  | 1           | A/ch    |
| MOS FET                         | Break Down Voltage                                     | V <sub>L</sub>   | 400         | V       |
|                                 | Continuous Load Current                                | I <sub>L</sub>   | 100         | mA/ch   |
|                                 | Pulse Load Current <sup>*2</sup><br>(AC/DC Connection) | I <sub>LP</sub>  | 200         | mA/ch   |
|                                 | Power Dissipation                                      | P <sub>D</sub>   | 375         | mW/ch   |
| Isolation Voltage <sup>*3</sup> |  | BV               | 1 500       | Vr.m.s. |
| Total Power Dissipation         |  | P <sub>T</sub>   | 850         | mW      |
| Operating Ambient Temperature   |  | T <sub>A</sub>   | -40 to +85  | °C      |
| Storage Temperature             |  | T <sub>stg</sub> | -40 to +100 | °C      |

\*1 PW = 100 μs, Duty Cycle = 1%

\*2 PW = 100 ms, 1 shot

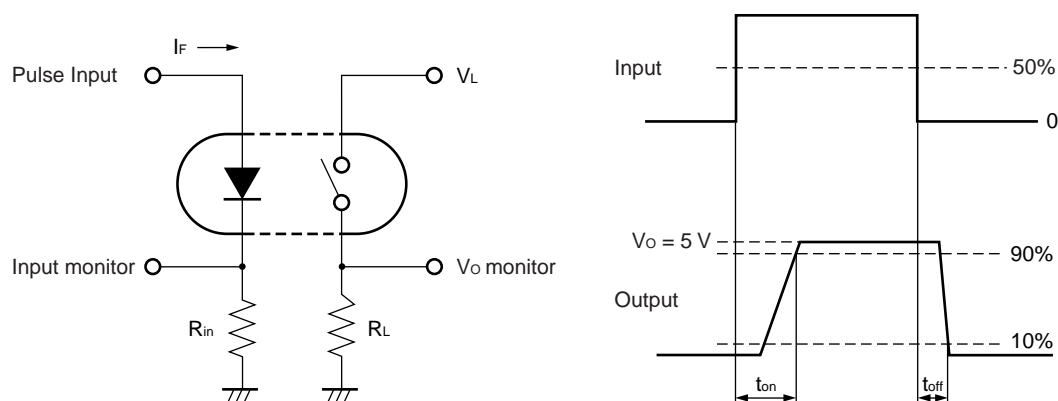
\*3 AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output  
Pins 1-4 shorted together, 5-8 shorted together.

**RECOMMENDED OPERATING CONDITIONS (T<sub>A</sub> = 25°C)**

| Parameter             | Symbol         | MIN. | TYP. | MAX. | Unit |
|-----------------------|----------------|------|------|------|------|
| LED Operating Current | I <sub>F</sub> | 5    | 10   | 20   | mA   |
| LED Off Voltage       | V <sub>F</sub> | 0    |      | 0.5  | V    |

**ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )**

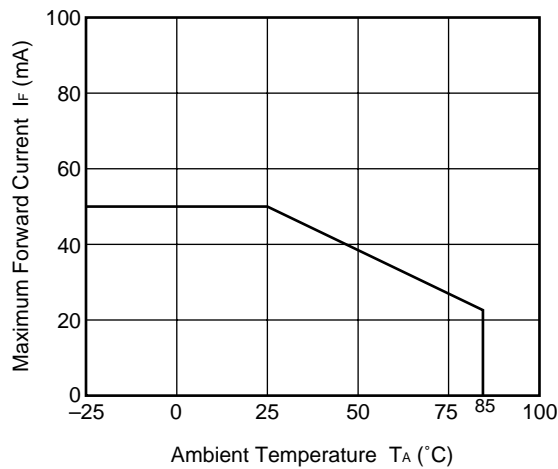
| Parameter |                               | Symbol            | Conditions   | MIN.   | TYP. | MAX. | Unit          |
|-----------|-------------------------------|-------------------|--|--------|------|------|---------------|
| Diode     | Forward Voltage               | $V_F$             | $I_F = 10\text{ mA}$   |        | 1.2  | 1.4  | V             |
|           | Reverse Current               | $I_R$             | $V_R = 5\text{ V}$   |        |      | 5.0  | $\mu\text{A}$ |
| MOS FET   | Off-state Leakage Current     | $I_{\text{Leak}}$ | $V_D = 400\text{ V}$   |        | 0.01 | 1.0  | $\mu\text{A}$ |
|           | Output Capacitance            | $C_{\text{out}}$  | $V_D = 0\text{ V}, f = 1\text{ MHz}$   |        | 36   |      | pF/ch         |
| Coupled   | LED On-state Current          | $I_{\text{Fon}}$  | $I_L = 100\text{ mA}$  |        |      | 5.0  | mA            |
|           | On-state Resistance           | $R_{\text{on1}}$  | $I_F = 10\text{ mA}, I_L = 10\text{ mA}$   |        | 36   | 50   | $\Omega$      |
|           |                               | $R_{\text{on2}}$  | $I_F = 10\text{ mA}, I_L = 100\text{ mA}, t \leq 10\text{ ms}$                             |        | 25   | 35   |               |
|           | Turn-on Time <sup>*1,2</sup>  | $t_{\text{on}}$   | $I_F = 10\text{ mA}, V_O = 5\text{ V}, R_L = 500\text{ }\Omega,$<br>$PW \geq 10\text{ ms}$ |        | 0.4  | 1.0  | ms            |
|           | Turn-off Time <sup>*1,2</sup> | $t_{\text{off}}$  |  |        | 0.07 | 0.2  |               |
|           | Isolation Resistance          | $R_{\text{I-O}}$  | $V_{\text{I-O}} = 1.0\text{ kV}_{\text{DC}}$   | $10^9$ |      |      | $\Omega$      |
|           | Isolation Capacitance         | $C_{\text{I-O}}$  | $V = 0\text{ V}, f = 1\text{ MHz}$   |        | 1.1  |      | pF/ch         |

**\*1 Test Circuit for Switching Time**

**\*2 The turn-on time and turn-off time are specified as input-pulse width  $\geq 10\text{ ms}$ .**

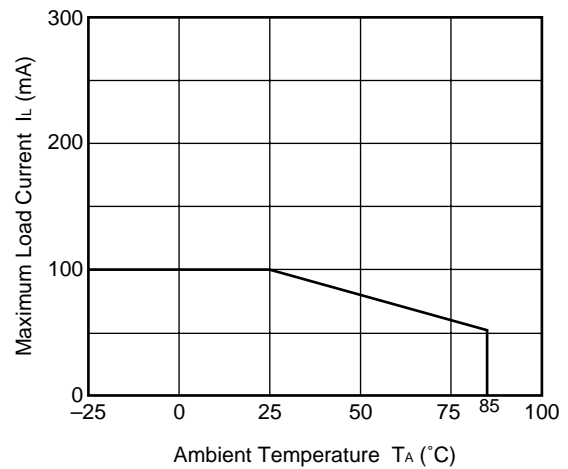
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

<R> **TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

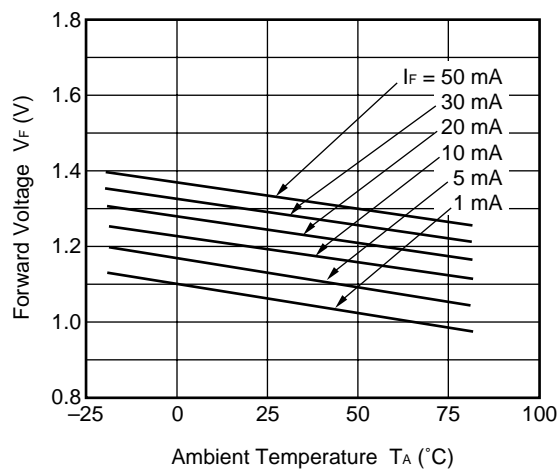
**MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE**



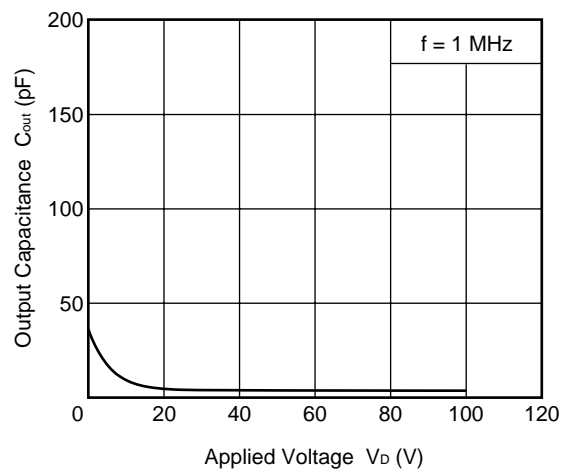
**MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE**



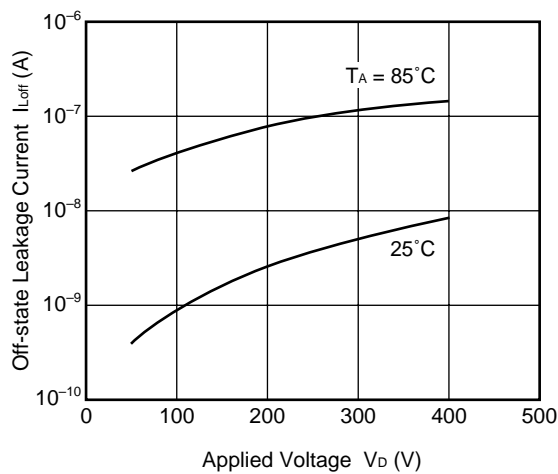
**FORWARD VOLTAGE vs. AMBIENT TEMPERATURE**



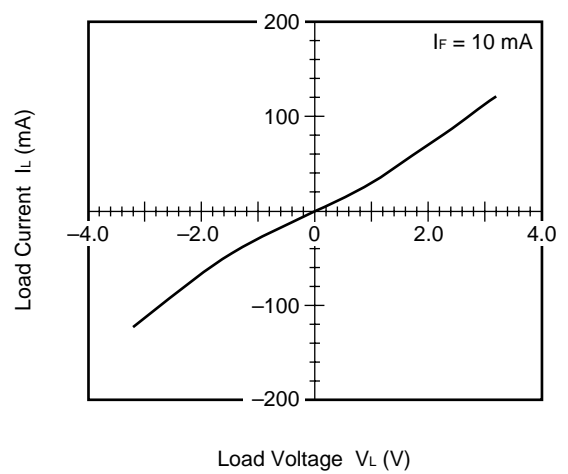
**OUTPUT CAPACITANCE vs. APPLIED VOLTAGE**



**OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE**

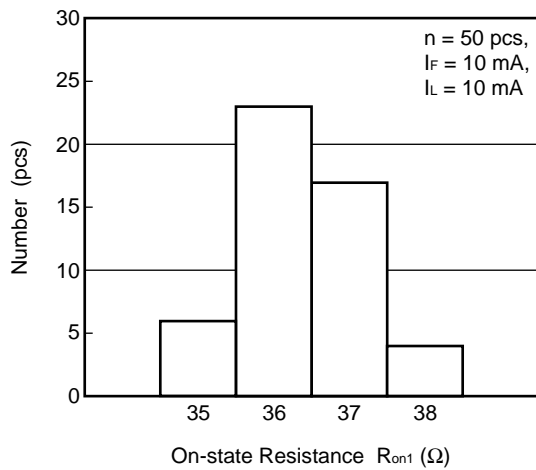


**LOAD CURRENT vs. LOAD VOLTAGE**

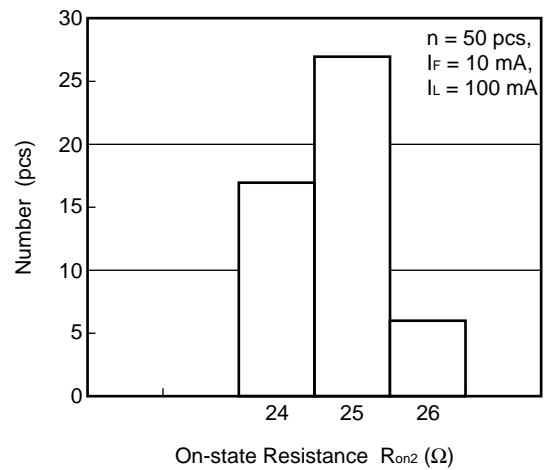


**Remark** The graphs indicate nominal characteristics.

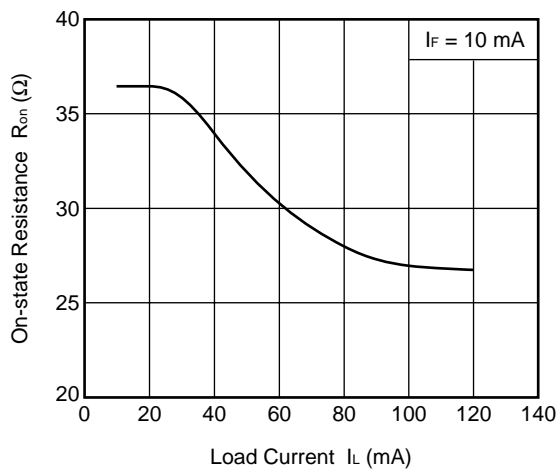
ON-STATE RESISTANCE DISTRIBUTION



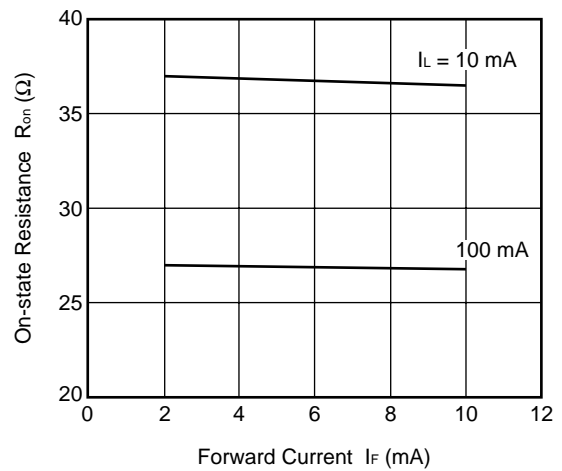
ON-STATE RESISTANCE DISTRIBUTION



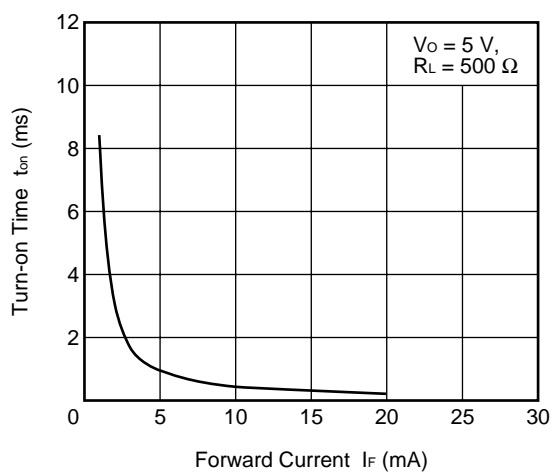
ON-STATE RESISTANCE vs.  
LOAD CURRENT



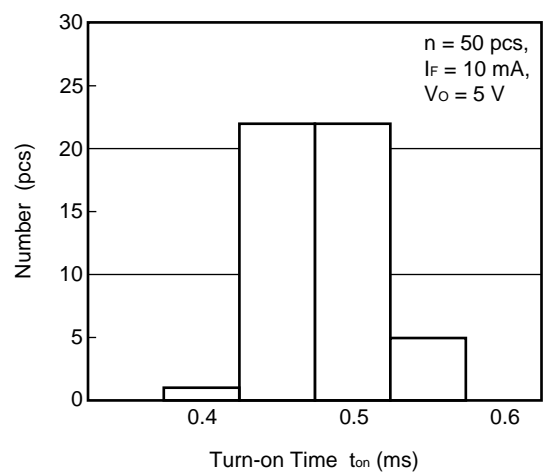
ON-STATE RESISTANCE vs.  
FORWARD CURRENT



TURN-ON TIME vs. FORWARD CURRENT

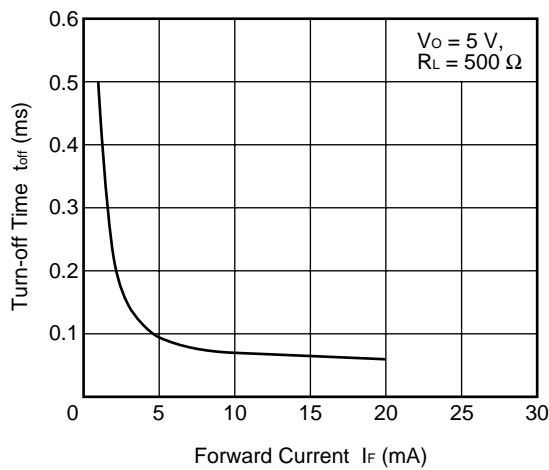


TURN-ON TIME DISTRIBUTION

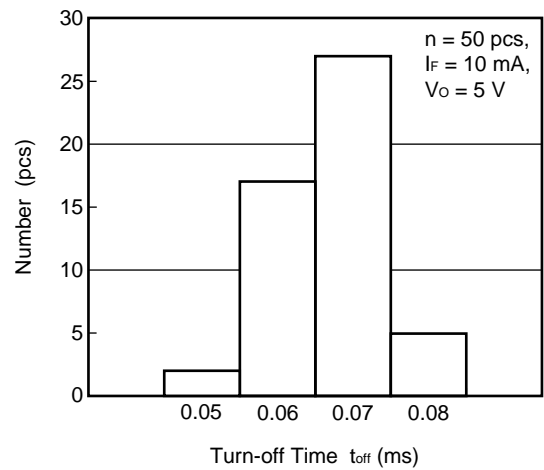


**Remark** The graphs indicate nominal characteristics.

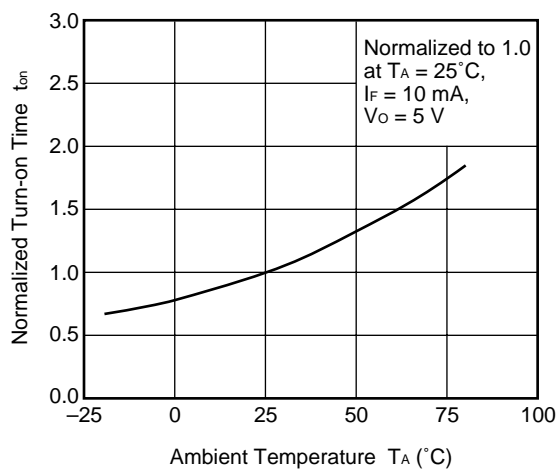
TURN-OFF TIME vs. FORWARD CURRENT



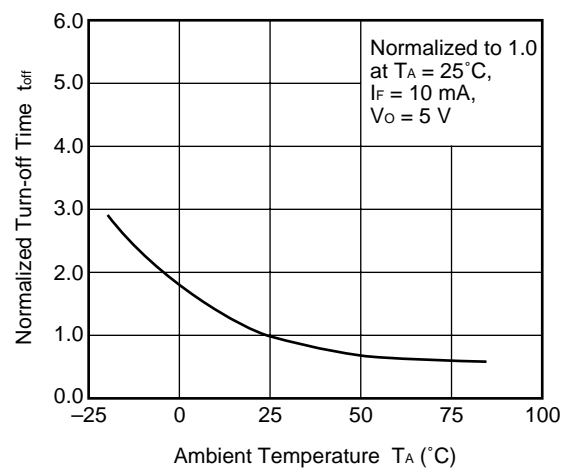
TURN-OFF TIME DISTRIBUTION



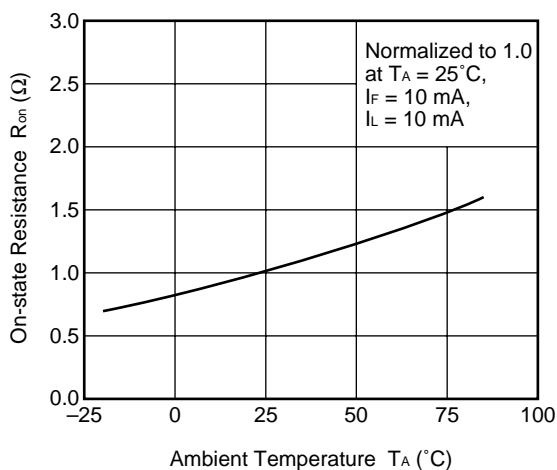
NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE



NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE

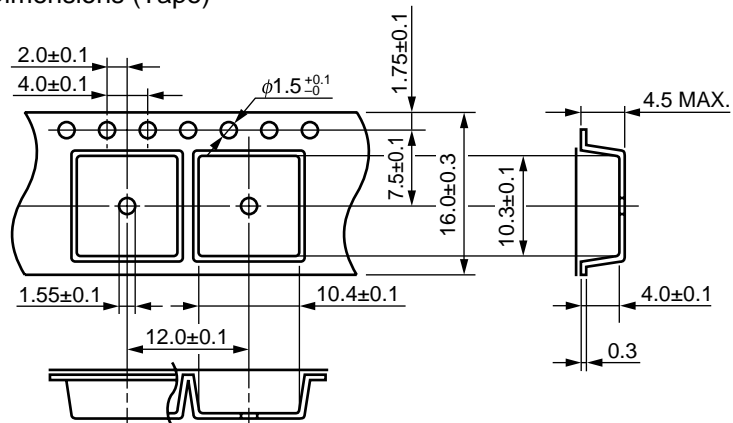


**Remark** The graphs indicate nominal characteristics.

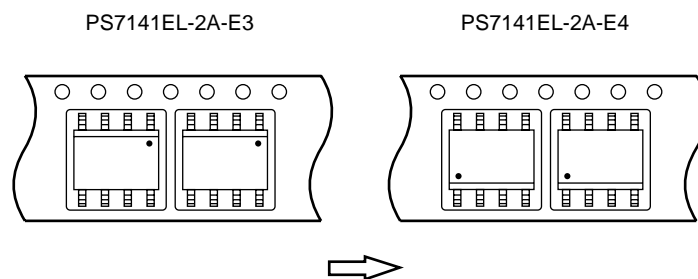


**TAPING SPECIFICATIONS (in millimeters)**

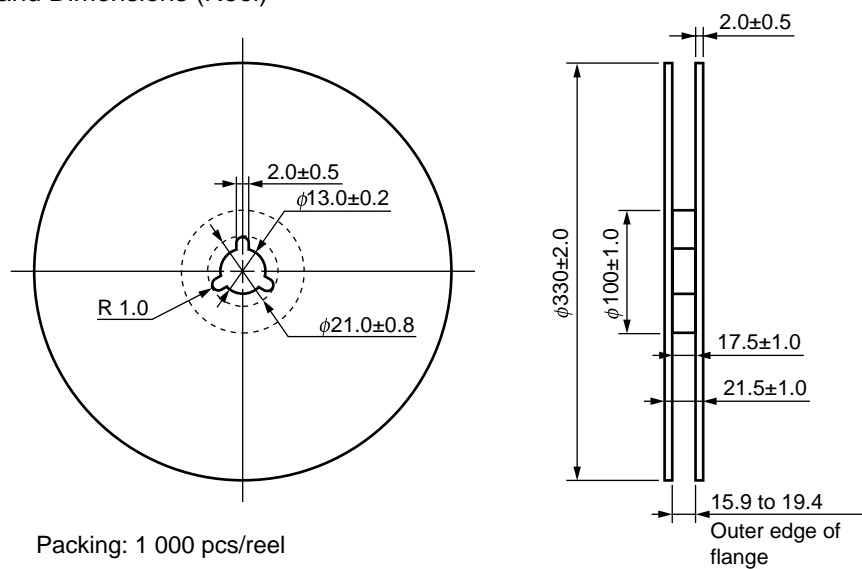
**Outline and Dimensions (Tape)**



**Tape Direction**



**Outline and Dimensions (Reel)**



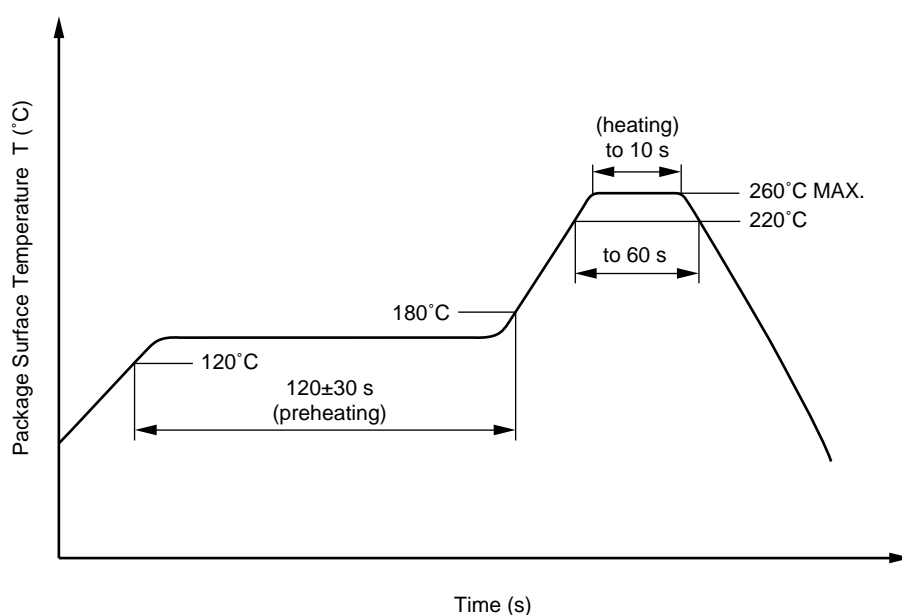
Packing: 1 000 pcs/reel

## RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

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### (3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

- Fluxes  
Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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**USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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|--|---|
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|--|---|

► For further information, please contact

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